



# BUK663R5-55C

N-channel TrenchMOS intermediate level FET

Rev. 2 — 23 December 2010

Product data sheet

## 1. Product profile

### 1.1 General description

Intermediate level gate drive N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using advanced TrenchMOS technology. This product has been designed and qualified to the appropriate AEC Q101 standard for use in high performance automotive applications.

### 1.2 Features and benefits

- AEC Q101 compliant
- Suitable for standard and logic level gate drive sources
- Suitable for thermally demanding environments due to 175 °C rating

### 1.3 Applications

- 12 V and 24 V Automotive systems
- Electric and electro-hydraulic power steering
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \geq 25^\circ\text{C}; T_j \leq 175^\circ\text{C}$	-	-	55	V
$I_D$	drain current	$V_{GS} = 10\text{ V}; T_{mb} = 25^\circ\text{C};$ see <a href="#">Figure 1</a>	[1]	-	-	120 A
$P_{tot}$	total power dissipation	$T_{mb} = 25^\circ\text{C}$ ; see <a href="#">Figure 2</a>	-	-	263	W
Static characteristics						
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 25\text{ A};$ $T_j = 25^\circ\text{C}$ ; see <a href="#">Figure 12</a>	-	2.86	3.4	$\text{m}\Omega$

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**Table 1.** Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Avalanche ruggedness</b>						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$I_D = 120 \text{ A}$ ; $V_{\text{sup}} \leq 55 \text{ V}$ ; $R_{GS} = 50 \Omega$ ; $V_{GS} = 10 \text{ V}$ ; $T_{j(\text{init})} = 25 \text{ }^\circ\text{C}$ ; unclamped; see <a href="#">Figure 3</a>	-	-	455	mJ
<b>Dynamic characteristics</b>						
$Q_{GD}$	gate-drain charge	$I_D = 25 \text{ A}$ ; $V_{DS} = 40 \text{ V}$ ; $V_{GS} = 10 \text{ V}$ ; see <a href="#">Figure 15</a> ; see <a href="#">Figure 14</a>	-	56	-	nC

[1] Continuous current is limited by package.

## 2. Pinning information

**Table 2.** Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	drain		
3	S	source		
mb	D	mounting base; connected to drain		
<b>SOT404 (D2PAK)</b>				

## 3. Ordering information

**Table 3.** Ordering information

Type number	Package		
	Name	Description	Version
BUK663R5-55C	D2PAK	plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped)	SOT404

## 4. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \geq 25^\circ\text{C}; T_j \leq 175^\circ\text{C}$	-	55	V
$V_{GS}$	gate-source voltage	DC	[1]	-16	V
		Pulsed	[2]	-20	V
$I_D$	drain current	$T_{mb} = 25^\circ\text{C}; V_{GS} = 10\text{ V}$ ; see <a href="#">Figure 1</a>	[3]	-	A
		$T_{mb} = 100^\circ\text{C}; V_{GS} = 10\text{ V}$ ; see <a href="#">Figure 1</a>	[3]	-	A
$I_{DM}$	peak drain current	$T_{mb} = 25^\circ\text{C}$ ; pulsed; $t_p \leq 10\ \mu\text{s}$ ; see <a href="#">Figure 4</a>	-	739	A
$P_{tot}$	total power dissipation	$T_{mb} = 25^\circ\text{C}$ ; see <a href="#">Figure 2</a>	-	263	W
$T_{stg}$	storage temperature		-55	175	°C
$T_j$	junction temperature		-55	175	°C
<b>Source-drain diode</b>					
$I_S$	source current	$T_{mb} = 25^\circ\text{C}$	[3]	-	A
$I_{SM}$	peak source current	pulsed; $t_p \leq 10\ \mu\text{s}; T_{mb} = 25^\circ\text{C}$	-	739	A
<b>Avalanche ruggedness</b>					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$I_D = 120\text{ A}; V_{sup} \leq 55\text{ V}; R_{GS} = 50\ \Omega;$ $V_{GS} = 10\text{ V}; T_{j(init)} = 25^\circ\text{C}$ ; unclamped; see <a href="#">Figure 3</a>	-	455	mJ
$E_{DS(AL)R}$	repetitive drain-source avalanche energy	see <a href="#">Figure 3</a>	[4][5][6]	-	J

[1] -16V accumulated duration not to exceed 168hrs.

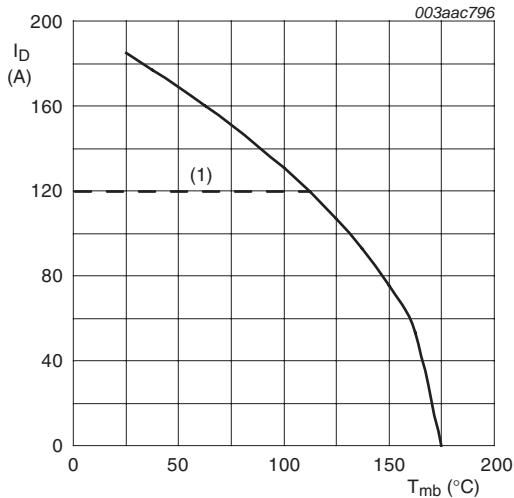
[2] Accumulated pulse duration not to exceed 5mins.

[3] Continuous current is limited by package.

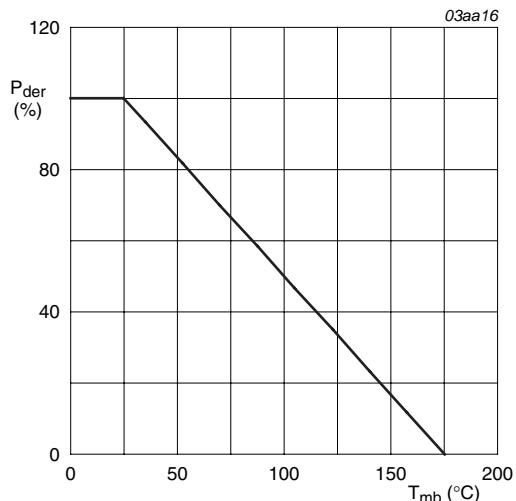
[4] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[5] Repetitive avalanche rating limited by an average junction temperature of 170 °C.

[6] Refer to application note AN10273 for further information.



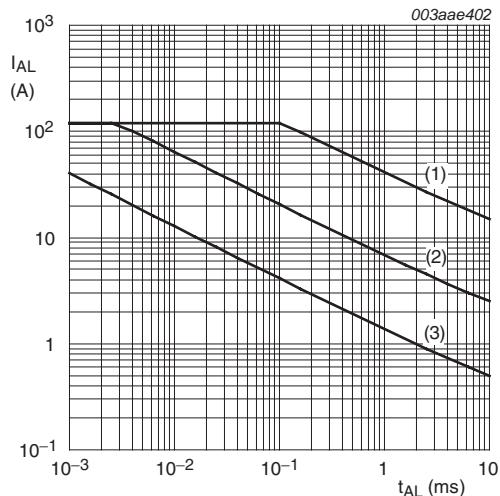
$V_{GS} \geq 10$  V; (1) Capped at 120 A due to package



$$P_{der} = \frac{P_{tot}}{P_{tot}(25^{\circ}\text{C})} \times 100 \%$$

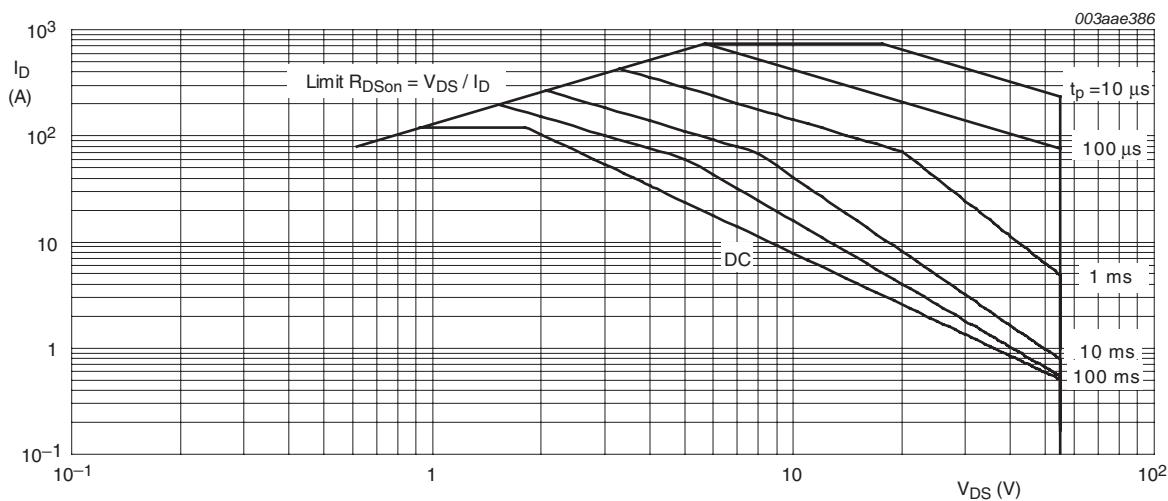
**Fig 1. Continuous drain current as a function of mounting base temperature**

**Fig 2. Normalized total power dissipation as a function of mounting base temperature**



(1) Single pulse;  $T_j = 25$   $^{\circ}$ C (2) Single pulse;  $T_j = 125$   $^{\circ}$ C (3) Repetitive pulse

**Fig 3. Single-pulse and repetitive avalanche rating; avalanche current as a function of avalanche time**



$T_{mb} = 25\ ^\circ C$ ;  $I_{DM}$  is a single pulse

Fig 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

## 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <a href="#">Figure 5</a>	-	-	0.57	K/W

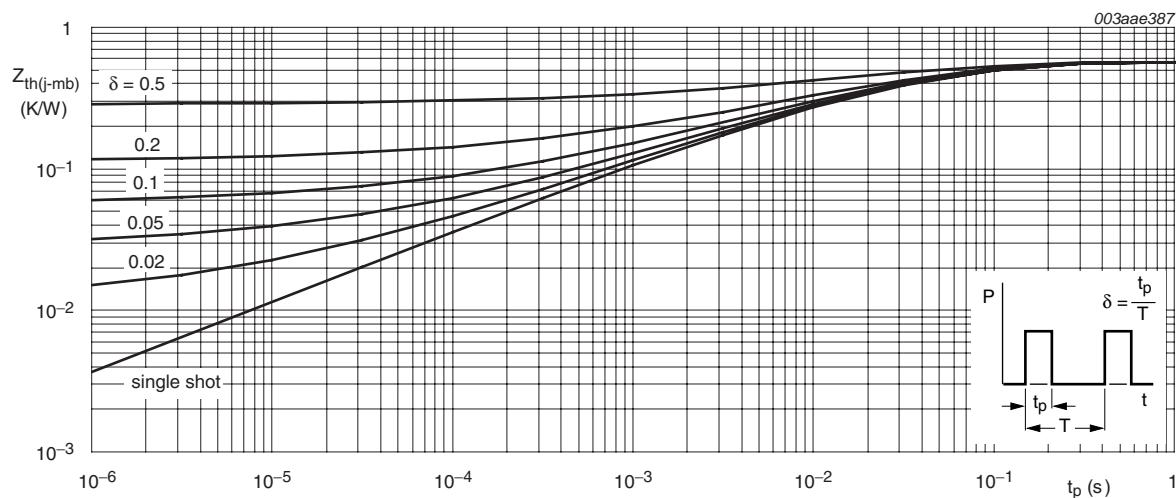


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

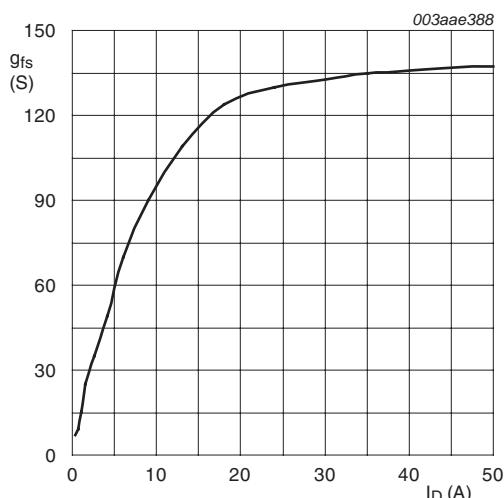
## 6. Characteristics

**Table 6. Characteristics**

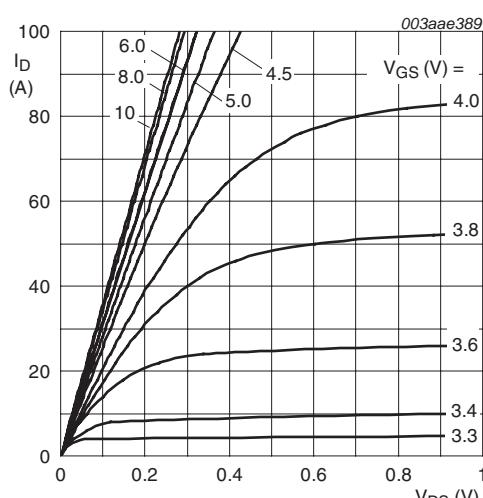
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static characteristics</b>						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25^\circ C$ $I_D = 250 \mu A; V_{GS} = 0 V; T_j = -55^\circ C$	55	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 mA; V_{DS} = V_{GS}; T_j = 25^\circ C;$ see <a href="#">Figure 10</a> ; see <a href="#">Figure 11</a> $I_D = 1 mA; V_{DS} = V_{GS}; T_j = -55^\circ C;$ see <a href="#">Figure 11</a> $I_D = 2.5 mA; V_{DS} = V_{GS}; T_j = 175^\circ C;$ see <a href="#">Figure 11</a>	1.8	2.3	2.8	V
$I_{DSS}$	drain leakage current	$V_{DS} = 55 V; V_{GS} = 0 V; T_j = 175^\circ C$ $V_{DS} = 55 V; V_{GS} = 0 V; T_j = 25^\circ C$	-	-	500	$\mu A$
$I_{GSS}$	gate leakage current	$V_{GS} = 20 V; V_{DS} = 0 V; T_j = 25^\circ C$ $V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25^\circ C$	-	2	100	nA
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 5 V; I_D = 25 A; T_j = 25^\circ C;$ see <a href="#">Figure 12</a> $V_{GS} = 10 V; I_D = 25 A; T_j = 25^\circ C;$ see <a href="#">Figure 12</a> $V_{GS} = 4.5 V; I_D = 25 A; T_j = 25^\circ C;$ see <a href="#">Figure 12</a> $V_{GS} = 10 V; I_D = 25 A; T_j = 175^\circ C;$ see <a href="#">Figure 13</a> ; see <a href="#">Figure 12</a>	-	3.42	4.3	$m\Omega$
<b>Dynamic characteristics</b>						
$Q_{G(tot)}$	total gate charge	$I_D = 25 A; V_{DS} = 40 V; V_{GS} = 10 V;$ see <a href="#">Figure 14</a> ; see <a href="#">Figure 15</a> $I_D = 25 A; V_{DS} = 40 V; V_{GS} = 5 V;$ see <a href="#">Figure 15</a> ; see <a href="#">Figure 14</a>	-	191	-	nC
$Q_{GS}$	gate-source charge	$I_D = 25 A; V_{DS} = 40 V; V_{GS} = 10 V;$ see <a href="#">Figure 15</a> ; see <a href="#">Figure 14</a>	-	28	-	nC
$Q_{GD}$	gate-drain charge		-	56	-	nC
$C_{iss}$	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$	-	8637	11516	pF
$C_{oss}$	output capacitance	$T_j = 25^\circ C$ ; see <a href="#">Figure 16</a>	-	819	982	pF
$C_{rss}$	reverse transfer capacitance		-	542	742	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 45 V; R_L = 1.8 \Omega; V_{GS} = 10 V;$	-	47	-	ns
$t_r$	rise time	$R_{G(ext)} = 10 \Omega$	-	93	-	ns
$t_{d(off)}$	turn-off delay time		-	156	-	ns
$t_f$	fall time		-	148	-	ns
$L_D$	internal drain inductance	from upper edge of drain mounting base to centre of die; $T_j = 25^\circ C$	-	3.5	-	nH
$L_S$	internal source inductance	from source lead to source bond pad; $T_j = 25^\circ C$	-	7.5	-	nH

**Table 6. Characteristics ...continued**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Source-drain diode</b>						
$V_{SD}$	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25^\circ\text{C}$ ; see <a href="#">Figure 17</a>	-	0.85	1.2	V
$t_{rr}$	reverse recovery time	$I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A}/\mu\text{s}; V_{GS} = 0 \text{ V}$	-	65	-	ns
$Q_r$	recovered charge	$V_{DS} = 25 \text{ V}$	-	148	-	nC



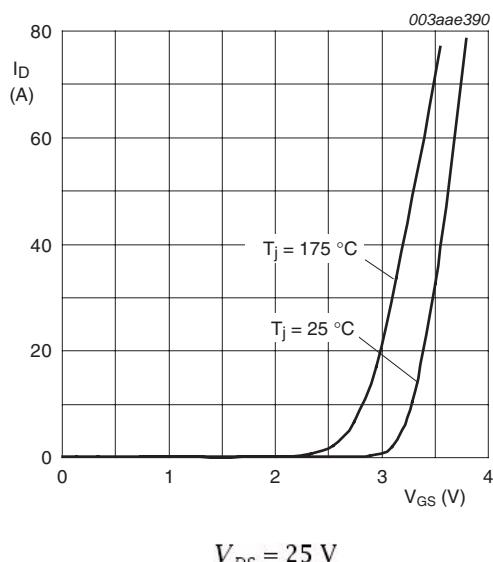
$T_j = 25^\circ\text{C}; V_{DS} = 25 \text{ V}$



$T_j = 25^\circ\text{C}; t_p = 300 \mu\text{s}$

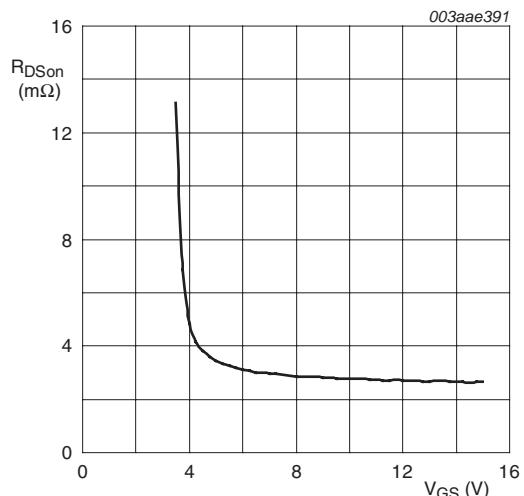
**Fig 6. Forward transconductance as a function of drain current; typical values**

**Fig 7. Output characteristics: drain current as a function of drain-source voltage; typical values**



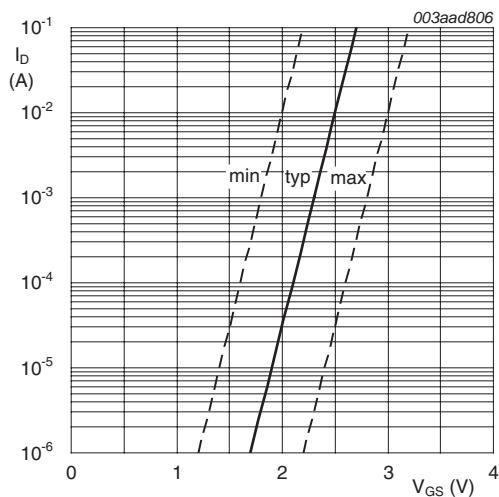
$V_{DS} = 25 \text{ V}$

**Fig 8. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



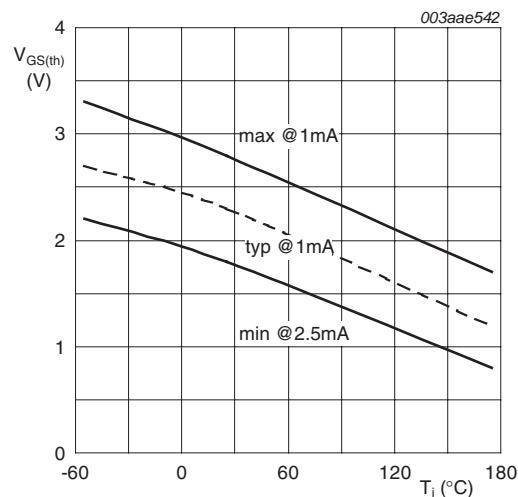
$T_j = 25^\circ\text{C}; I_D = 25 \text{ A}$

**Fig 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**



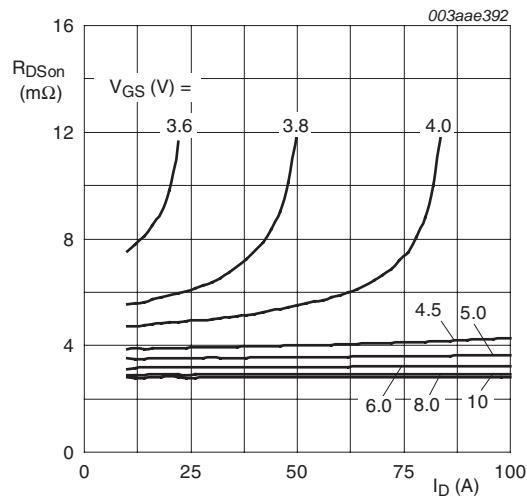
$T_j = 25^\circ\text{C}; V_{DS} = 5\text{V}$

**Fig 10. Sub-threshold drain current as a function of gate-source voltage**



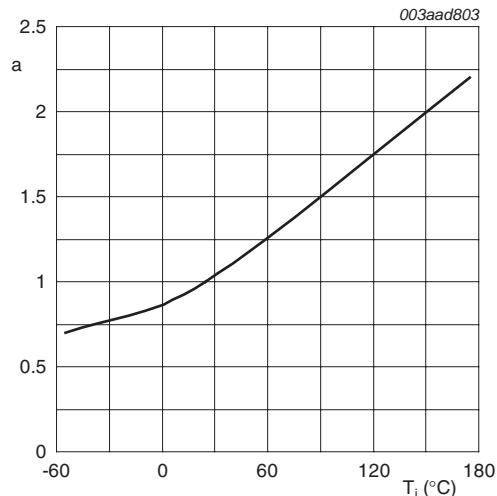
$I_D = 1\text{mA}; V_{DS} = V_{GS}$

**Fig 11. Gate-source threshold voltage as a function of junction temperature**



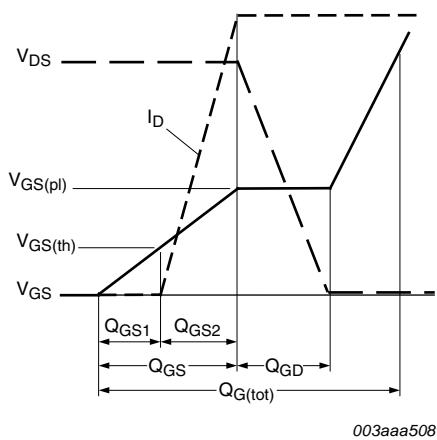
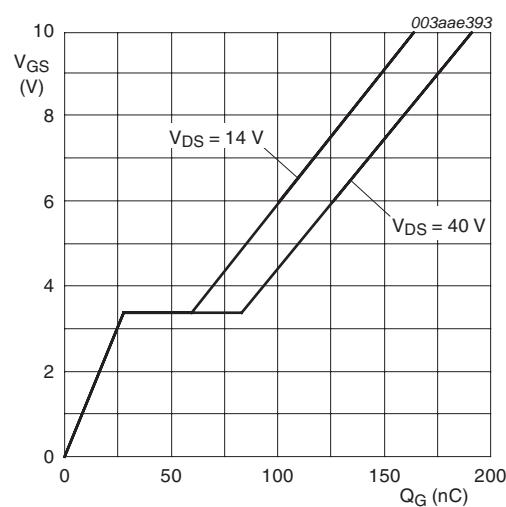
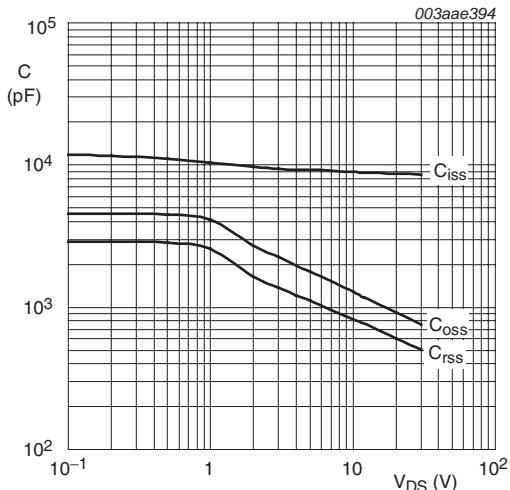
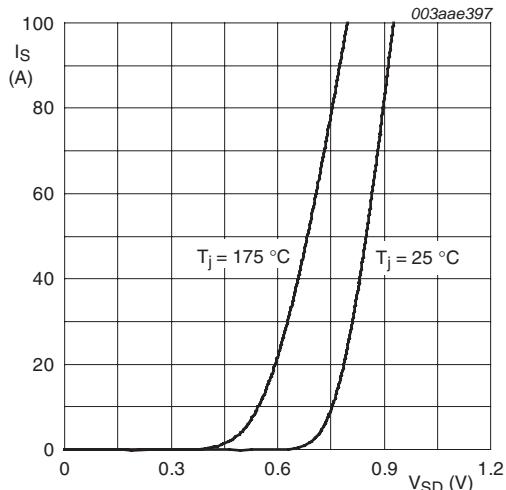
$T_j = 25^\circ\text{C}; t_p = 300\ \mu\text{s}$

**Fig 12. Drain-source on-state resistance as a function of drain current; typical values**



$$a = \frac{R_{DS(\text{on})}}{R_{DS(\text{on})}(25^\circ\text{C})}$$

**Fig 13. Normalized drain-source on-state resistance factor as a function of junction temperature**

**Fig 14. Gate charge waveform definitions****Fig 15. Gate-source voltage as a function of gate charge; typical values****Fig 16. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values****Fig 17. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values**

## 7. Package outline

Plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped)

SOT404

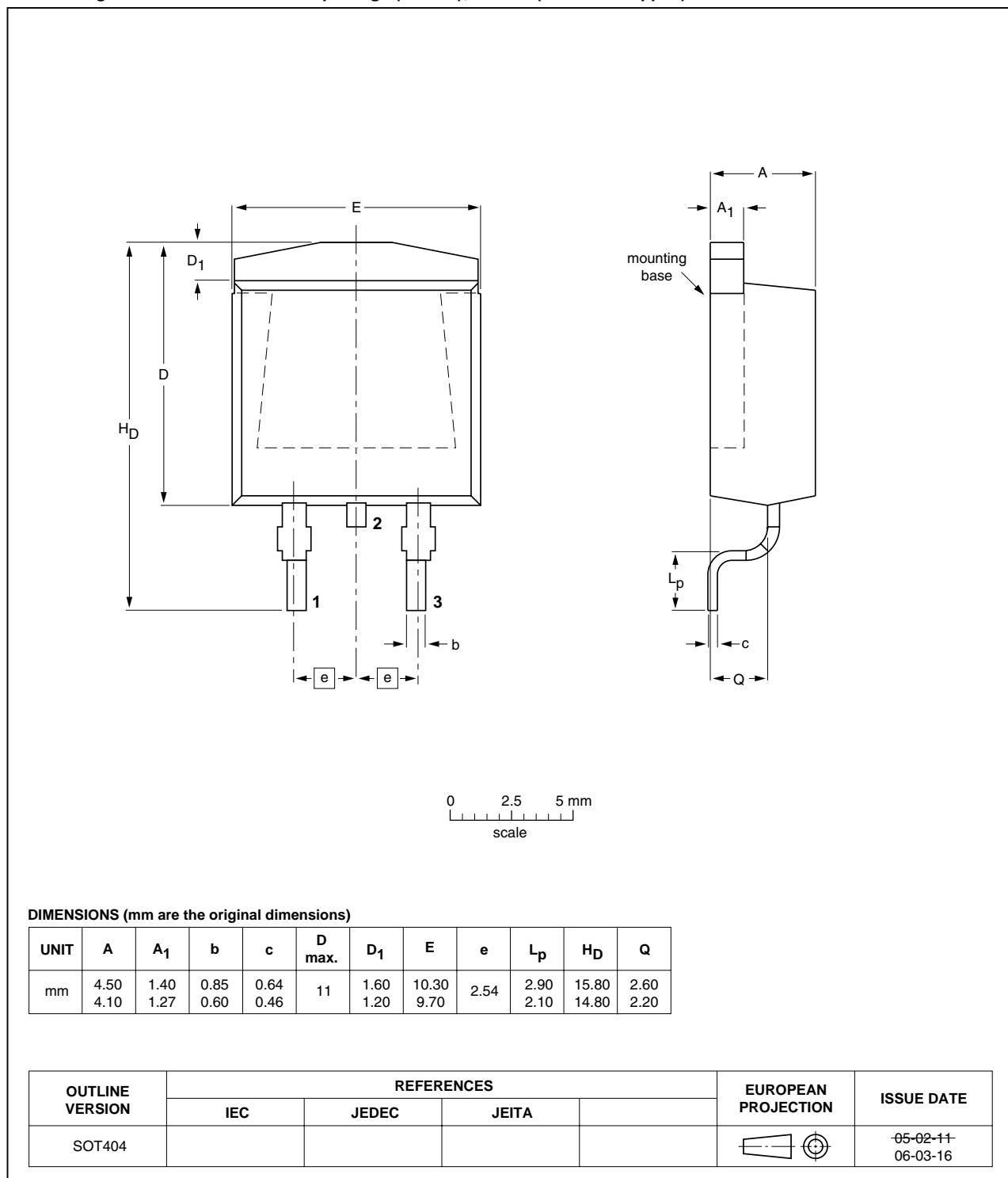


Fig 18. Package outline SOT404 (D2PAK)

## 8. Revision history

**Table 7. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK663R5-55C v.2	20101223	Product data sheet	-	BUK663R5-55C v.1
Modifications:		<ul style="list-style-type: none"><li>• Status changed from objective to product.</li><li>• Various changes to content.</li></ul>		
BUK663R5-55C v.1	20100803	Objective data sheet	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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